

Thunder & Tempest Solutions 4th Gen Intel® Xeon® Scalable Processors







Leading performance with the most built-in accelerators



4th Gen Intel® Xeon® Scalable processors are designed to accelerate performance across the fastest-growing workloads that businesses depend on today. The processor is supported by a rich set of platform enhancements that drives the adoption of industry-changing technologies like DDR5 memory, advanced I/O with PCIe Gen 5 and Compute Express Link (CXL).

Built-in accelerators improve performance across AI, analytics, networking, storage, and HPC. By making the best use of CPU core resources, built-in accelerators can result in more efficient utilization and power efficiency advantages, helping businesses achieve their sustainability goals.

New Features of 4th Gen Intel® Xeon® Scalable processors

Intel® Advanced Matrix Extensions (Intel® AMX)

Significantly accelerate AI capabilities on the CPU with Intel Advanced Matrix Extensions (Intel AMX). Intel AMX is a built-in accelerator that improves the performance of deep learning training and inference on 4th Gen Intel® Xeon® Scalable processors, ideal for workloads like natural language processing, recommendation systems, and image recognition.

Intel® QuickAssist Technology (Intel® QAT)

Help reduce system resource consumption by providing accelerated cryptography, key protection, and data compression with Intel QuickAssist Technology (Intel QAT). By offloading encryption and decryption, this built-in accelerator helps free up processor cores and helps systems serve a larger number of clients.

Intel® Data Streaming Accelerator (Intel® DSA)

Drive high performance for storage, networking, and data-intensive workloads by improving streaming data movement and transformation

operations. Intel Data Streaming Accelerator (Intel® DSA) is designed to offload the most common data movement tasks that cause overhead in data center-scale deployments. Intel® DSA helps speed up data movement across the CPU, memory, and caches, as well as all attached memory, storage, and network devices.

Intel® Dynamic Load Balancer (Intel® DLB)

Improve the system performance related to handling network data on multi-core Intel® Xeon® Scalable processors. Intel® Dynamic Load Balancer (Intel® DLB) enables the efficient distribution of network processing across multiple CPU cores/threads and dynamically distributes network data across multiple CPU cores for processing as the system load varies. Intel® DLB also restores the order of networking data packets processed simultaneously on CPU cores.

Intel® In-Memory Analytics Accelerator (Intel® IAA)

Run database and analytics workloads faster, with potentially greater power efficiency. Intel In-Memory Analytics Accelerator (Intel® IAA) increases query throughput and decreases the memory footprint for in-memory database and big data analytics workloads. Intel® IAA is ideal for in-memory databases, open source databases and data stores like RocksDB, Redis, Cassandra, and MySQL.

Compute Express Link (CXL)

Reduce compute latency in the data center and lower TCO with Compute Express Link (CXL) 1.1 for next-generation workloads. CXL is an alternate protocol that runs across the standard PCIe physical layer and can support both standard PCIe devices as well as CXL devices on the same link. CXL provides a critical capability to create a unified, coherent memory space between CPUs and accelerators and will revolutionize how data center server architectures will be built for years to come.

Software and workloads used in performance tests may have been optimized for performance only on Intel microprocessors. Performance tests are measured using specific computer systems, components, software, operations and functions. Any change to any of those factors may cause the results to vary.

TYAN Brand Lines

Tyan is pleased to announce a new line of server barebones and motherboards designed to suit the needs of the channel and our system integration partners.

Thunder and Tempest products spanning four product segments:

SX – Storage

HX - HPC

CX - Cloud

EX – Embedded

Tyan continually develops a roadmap full of innovative new products. Check our website at www.tyan.com to stay up to date with our latest product offerings.

Thunder



The Tyan **Thunder** series is a line of server barebones based on Intel's latest technology including the Intel® Xeon® Scalable Processors. These barebones are designed to offer best-in-class server technology to our customers. Tyan Thunder server barebones are built to inventory and are warehoused locally in the USA.

Tempest



Tyan's **Tempest** line of motherboards are designed to pack the latest Intel's world-class server technology into off-the-shelf commodity chassis, providing an outstanding server building block for the widest possible range of applications. Like Tyan's Thunder server barebones, these motherboards are warehoused in the USA and are readily available in the channel.

Thunder HX FT65T-B7130





















Pedestal/4U 2S HPC server platform supports multiple high performance GPU cards

Model Number		FT65T-B7130		
Enclosure Form Factor	Ped	lestal / 4U (25.59" in dep	oth)	
Supported CPU	(2) 4 th Gen.	Intel® Xeon® Scalable F	rocessor	
Chipset		Intel® C741 PCH		
Number of DIMM Slot	16 / 8+8			
Memory Type (max. capacity)	Follow the latest 4 th Gen. *: Actual memory	Intel® Xeon® Scalable Pr speed depends on popu		
Storage Controller		Intel® C741 PCH		
RAID Support	RAID	0, 1, 10, 5 (Intel® VROC	C 8.0)	
Networking	(2) 10GBase-T ports (Intel® x710-AT2) + (1) 1000Base-T port dedicate for IPMI (Realtek® RTL8211FD-CG)			
PCI Expansion Slots	(3) PCle 5.0 x16 + (2) PCle 5.0 x8 slots + (1) PCle 4.0 x4 NVMe M.2 slot			
Power Supply	(1) 2,000W (@220V _{AC}) ATX PSU			
Standard Model	# Storage Bay	# FAN	Networking	
B7130F65TV10H-2T-N	(8) 3.5" hot-swap SATA + (2) 2.5" hot-swap SATA	(3) hot-swap 12038 + (2) cold-swap 8038	(2) 10GBase-T + (1) 1000Base-T (IPMI)	
B7130F65TV10H-2T-G	(8) 3.5" hot-swap SATA + (2) 2.5" hot-swap SATA	(3) hot-swap 12038	(2) 10GBase-T + (1) 1000Base-T (IPMI)	

Server Board

Tempest HX S7130









Dual-socket mainstream server board in EEB form factor



Processor	• (2) 4th Gen. Intel® Xeon® Scalable Processor
Memory	• (8+8) DDR5 DIMM slots
Expansion	• (3) PCle 5.0 x16 slots • (2) PCle 5.0 x8 slots
Storage	• (10) SATA 6Gb/s
Network	(2) 10GBase-T ports (Intel® x710-AT2) (-2T SKU) (1) 1000Base-T port dedicate for IPMI (Realtek® RTL8211FD-CG)
Video	ASPEED AST2600 Integrated Graphics
Management	ASPEED AST2600 iBMC w/ iKVM
Form Factor	• EEB 12" x 13"

Standard Model	SATA	NVMe	10GbE	ВМС
S7130GM2NRE-2T	10	(1) M.2	2	Yes
S7130GMRE	10	(1) M.2	-	Yes

Thunder HX FT65T-B5652





















Pedestal/4U1S server platform designed for deskside HPC/GPGPU applications supporting up to 4 double-wide GPU cards

Model Number		FT65T-B5652		
Enclosure Form Factor	Pede	estal / 4U (25.59" in depth	1)	
Supported CPU	(1) 4 th Gen.	Intel® Xeon® Scalable Pr	ocessor	
Chipset		Intel® C741 PCH		
Number of DIMM Slot	8			
Memory Type (max. capacity) Storage Controller		Follow the latest 4th Gen. Intel® Xeon® Scalable Processor Memory POR* *: Actual memory speed depends on populated CPU models Intel® C741 PCH		
RAID Support	RAID 0, 1, 10, 5 (Intel® VROC 8.0)			
Networking	(2) 10GBase-T (Intel® x550-AT2) (-2T SKU only) + (1) 1000Base-T (Intel® i210-AT) + (1) 1000Base-T port dedicate for IPMI (Realtek® RTL8211FD-CG)			
PCI Expansion Slots	(4) PCle 5.0 x16 + (1) PCle 5.0 x4 slots + (1) PCle 3.0 x2 NVMe M.2 slot			
Power Supply	(1) 2,000W (@220V _{AC}) ATX PSU			
Standard Model	# Storage Bay	# FAN	Networking	
B5652F65TV6E2H-2T-N	(6) 3.5" hot-swap SATA + (2) 2.5" hot-swap U.2	(3) hot-swap 12038 + (2) cold-swap 8038	(2) 10GBase-T + (1) 1000Base-T (1) 1000Base-T (IPMI)	
B5652F65TV6E2H-G	(6) 3.5" hot-swap SATA + (2) 2.5" hot-swap U.2	(3) hot-swap 12038	(1) 1000Base-T + (1) 1000Base-T (IPMI)	

Thunder HX TS75A-B7132



















2U2S server platform with maximum memory capacity for in-memory computing and virtualization

Model Number		TS75A-B7132		
Enclosure Form Factor		2U (29.53" in depth)		
Supported CPU	(2) 4 th Gen. I	ntel® Xeon® Scalable Pi	rocessor	
Chipset		Intel® C741 PCH		
Number of DIMM Slot	32 / 16+16			
Memory Type (max. capacity)	Follow the latest 4th Gen. Intel® Xeon® Scalable Processor Memory POR* *: Actual memory speed depends on populated CPU models			
Storage Controller		Intel® C741 PCH		
RAID Support	RAID 0), 1, 10, 5 (Intel® VROC	8.0)	
Networking	(2) 10GBase-T (Intel® x710-AT2) or (2) 1000Base-T (2x Intel® i210-AT) ports + (1) 1000Base-T port dedicate for IPMI (Realtek® RTL8211FD-CG)			
	(4) PCle 5.0 x16 + (1) PCle 5.0 x4 slots (via risers) + (1) OCP v3.0 LAN mezzanine slot + (2) PCle 4.0 x4 NVMe M.2 slots			
PCI Expansion Slots	(1) OCF	v3.0 LAN mezzanine s	slot +	
PCI Expansion Slots Power Supply	(1) OCF (2) Po	v3.0 LAN mezzanine s	slot + ots	
	(1) OCF (2) Po	V3.0 LAN mezzanine s Cle 4.0 x4 NVMe M.2 sl	slot + ots	
Power Supply	(1) OCF (2) P((1+1) :	o v3.0 LAN mezzanine s Cle 4.0 x4 NVMe M.2 sl 2,000W (@220V _{AC}) CRF	slot + ots	

Thunder SX TS70A-B7136















2U2S server platform for high IOPs cloud storage applications





	TS70A-B7136		
	2U (27.56" in depth)		
(2) 4	th Gen. Intel [®] Xeon [®] Scalable F	rocessor	
	Intel® C741 PCH		
	16 / 8+8		
	Follow the latest 4th Gen. Intel® Xeon® Scalable Processor Memory POR* *: Actual memory speed depends on populated CPU models		
	Intel® C741 PCH		
	RAID 0, 1, 10, 5 (Intel® VROC	8.0)	
(2) 10GBase-T (Intel® x710-AT2) ports + (1) 1000Base-T port dedicate for IPMI (Realtek® RTL8211FD-CG)			
(2) PCle 5.0 x16	(2) PCle 5.0 x16 + (2) PCle 5.0 x8 + (1) PCle 5.0 x4 slots (via risers) + (1) OCP v3.0 LAN mezzanine slot + (2) PCle 4.0 x4 NVMe M.2 slots		
	(1) 1,200W (@220V _{AC}) CRPS		
# Storage Bay	# PCIe Slots	Networking	
(12) 2.5" hot-swap SATA + (8) 2.5" hot-swap U.2	(2) PCle 5.0 x16 + (2) PCle 5.0 x8 + (1) PCle 5.0 x4 + (1) OCP v3.0 mezz. + (2) M.2	(2) 10GBase-T + (1) 1000Base-T (IPMI)	
(12) 2.5" hot-swap SATA + (8) 2.5" hot-swap U.2	(2) PCIe 5.0 x16 + (2) PCIe 5.0 x8 + (1) PCIe 5.0 x4 + (1) OCP v3.0 mezz. + (2) M.2	(1) 1000Base-T (IPMI)	
	# Storage Bay (12) 2.5" hot-swap SATA + (8) 2.5" hot-swap	2U (27.56" in depth) (2) 4th Gen. Intel® Xeon® Scalable F Intel® C741 PCH 16 / 8+8 Follow the latest 4th Gen. Intel® Xeon® Scalable P *: Actual memory speed depends on popu Intel® C741 PCH RAID 0, 1, 10, 5 (Intel® VROC (2) 10GBase-T (Intel® x710-AT2) (1) 1000Base-T port dedicate for IPMI (Realte (2) PCle 5.0 x16 + (2) PCle 5.0 x8 + (1) PCle 5 (1) OCP v3.0 LAN mezzanine (2) PCle 4.0 x4 NVMe M.2 s (1) 1,200W (@220V _{AC}) CRF # Storage Bay (12) 2.5" hot-swap SATA + (2) PCle 5.0 x8 + (1) PCle 5.0 x4 + (1) OCP v3.0 mezz. + (2) M.2 (12) 2.5" hot-swap SATA + (2) PCle 5.0 x8 + (3) PCle 5.0 x8 + (4) PCle 5.0 x8 + (5) PCle 5.0 x8 + (7) PCle 5.0 x8 + (8) 2.5" hot-swap SATA + (9) PCle 5.0 x8 + (9) PCle 5.0 x8 + (1) PCle 5.0 x8 + (1) PCle 5.0 x8 + (2) PCle 5.0 x8 + (3) PCle 5.0 x8 + (4) PCle 5.0 x8 + (5) PCle 5.0 x8 + (8) 2.5" hot-swap SATA + (2) PCle 5.0 x8 + (9) PCle 5.0 x8 + (1) PCle 5.0 x8 + (1) PCle 5.0 x8 + (2) PCle 5.0 x8 + (3) PCle 5.0 x8 + (4) PCle 5.0 x8 + (5) PCle 5.0 x8 + (7) PCle 5.0 x8 + (8) 2.5" hot-swap SATA + (2) PCle 5.0 x8 + (9) PCle 5.0 x8 + (1) PCle 5.0 x8 + (1) PCle 5.0 x8 + (2) PCle 5.0 x8 + (3) PCle 5.0 x8 + (4) PCle 5.0 x8 + (5) PCle 5.0 x8 + (7) PCle 5.0 x8 + (8) 2.5" hot-swap SATA + (8) 2.5" hot-swap SATA + (9) PCle 5.0 x8 + (1) PCle 5.0 x8 +	

Thunder CX TD76-B5658



















2U 4-node server platform designed for high-density cloud server deployment

Model Number		TD76-B5658		
Enclosure Form Factor		2U (29.92" in depth)		
Supported CPU	(1) 4 th Gen. Intel	® Xeon® Scalable Proc	essor (per node)	
Chipset	Intel® C741 PCH			
Number of DIMM Slot	16 (per node)			
Memory Type (max. capacity)		Follow the latest 4th Gen. Intel® Xeon® Scalable Processor Memory POR* *: Actual memory speed depends on populated CPU models		
Storage Controller		Intel® C741 PCH		
RAID Support	RAID 0, 1, 10, 5 (Intel® VROC 8.0)			
Networking	(1) 1000Base-T (Intel® i210-AT) + (1) 1000Base-T port dedicate for IPMI (Realtek® RTL8211FD-CG) (per node)			
PCI Expansion Slots	(1) PCIe 5.0 x16 slot + (1) OCP v3.0 LAN mezzanine slot + (2) PCIe 3.0 x4 NVMe M.2 slot (per node)			
Power Supply	(1+1) 2,700W	(@220V _{AC}) CRPS PS	U (per system)	
Standard Model	# Storage Bay (per node)	# FAN (per system)	Networking (per node)	
B5658T76X4-270TE4HR	(4) hot-swap E1.s	(4) hot-swap 8056	(1) 1000Base-T + (1) 1000Base-T (IPMI)	

Thunder CX GC79A-B7132



















1U2S server platform with maximum memory capacity for high-performance in-memory

Model Number		GC79A-B7132		
Enclosure Form Factor		1U (31.1" in depth)		
Supported CPU	(2) 4th Gen.	Intel® Xeon® Scalable Pi	rocessor	
Chipset		Intel® C741 PCH		
Number of DIMM Slot	32 / 16+16			
Memory Type (max. capacity)	Follow the latest 4th Gen. Intel® Xeon® Scalable Processor Memory POR* *: Actual memory speed depends on populated CPU models			
Storage Controller	Intel® C741 PCH			
RAID Support	RAID 0, 1, 10, 5 (Intel® VROC 8.0)			
Networking	(2) 10GBase-T (Intel® x710-AT2) or (2) 1000Base-T (2x Intel® i210-AT) ports + (1) 1000Base-T port dedicate for IPMI (Realtek® RTL8211FD-CG)			
PCI Expansion Slots	(2) PCle 5.0 x16 (via risers) + (1) OCP v3.0 LAN mezzanine slot + (2) PCle 4.0 x4 NVMe M.2 slots			
Power Supply	(1+1) 1,200W (@220V _{AC}) CRPS			
Standard Model	# Storage Bay	# PCIe Slots	Networking	
B7132G79AE12HR-2T	(12) 2.5" hot-swap U.2 (up to 4x SATA)	(2) PCle 5.0 x16 + (1) OCP v3.0 mezz. + (2) M.2	(2) 10GBase-T + (1) 1000Base-T (IPM	
B7132G79AE12HR	(12) 2.5" hot-swap U.2 (up to 4x SATA)	(2) PCle 5.0 x16 + (1) OCP v3.0 mezz. + (2) M.2	(2) 1000Base-T + (1) 1000Base-T (IPM	

Thunder CX GC68A-B7136



















1U2S server platform for mainstream cloud applications

Model Number		GC68A-B7136		
Enclosure Form Factor		1U (26.77" in depth)		
Supported CPU	(2) 4th Gen.	Intel® Xeon® Scalable Pi	rocessor	
Chipset		Intel® C741 PCH		
Number of DIMM Slot	16 / 8+8			
Memory Type (max. capacity)	Follow the latest 4th Gen. Intel® Xeon® Scalable Processor Memory POR* *: Actual memory speed depends on populated CPU models			
Storage Controller		Intel® C741 PCH		
RAID Support	RAID	0, 1, 10, 5 (Intel® VROC	8.0)	
Networking	(2) 10GBase-T (Intel® x710-AT2) ports + (1) 1000Base-T port dedicate for IPMI (Realtek® RTL8211FD-CG)			
PCI Expansion Slots	(2) PCle 5.0 x16 slots (via risers) + (1) OCP v3.0 LAN mezzanine slot + (2) PCle 4.0 x4 NVMe M.2 slots			
Power Supply		(1+1) 850W RPSU		
Standard Model	# Storage Bay	# PCle Slots	Networking	
B7136G68AV4E8HR-2T	(8) 2.5" hot-swap U.2 + (4) 2.5" hot-swap SATA	(2) PCle 5.0 x16 + (1) OCP v3.0 mezz. + (2) M.2	(2) 10GBase-T + (1) 1000Base-T (IPMI)	
B7136G68AV4E8HR	(8) 2.5" hot-swap U.2 + (4) 2.5" hot-swap SATA	(2) PCle 5.0 x16 + (1) OCP v3.0 mezz. + (2) M.2	(1) 1000Base-T (IPMI)	

Server Board

Tempest HX S5652















Tempest CX

S7136













Single-socket HPC server board for multiple GPU cards deployment

Processor	· (1) 4 th (Gen. Intel® Xeon® Sca	alable Pro	cessor	
Memory	• (8) DD	R5 DIMM slots			
Expansion	• (1) PCI • (1) PCI	e 5.0 x16 slots e 5.0 x8 slot (w/ x4 lir e 5.0 MCIO x8 conne Me M.2 slot	,	J.2	
Storage	• (6) SAT	A 6Gb/s			
Network	· (1) 100 · (1) 100	GBase-T ports (Intel®) 10Base-T port (Intel® i 10Base-T port dedicat ek®RTL8211FD-CG)	210-AT)		U only)
Video	· ASPEE	D AST2600 Integrate	d Graphi	cs	
Management	· ASPEE	D AST2600 iBMC w/ i	KVM		
Form Factor	• CEB 12	2" x 10.5"			
Standard Model	SATA	NVMe	10GbE	GbE	ВМС
S5652AGM3NRE-2T	. 6	(1) MCIO x8 + (1) M.:	2 2	1	Yes

(1) MCIO x8 + (1) M.2

Dual-socket rack-optimized server board for 1U/2U deployment

Processor	• (2) 4 th (Gen. Intel® Xeon® Scalable	Processor	
Memory	• (8+8) D	DDR5 DIMM slots		
Expansion	• (1) PCI • (1) OCI • (8) PCI	(1) PCle 5.0 x28 riser slot (1) PCle 5.0 x24 riser slot (1) OCP v3.0 mezz. slot (8) PCle 5.0 MClO x4 connectors for U.2 (2) NVMe M.2		
Storage	• (14) SA	• (14) SATA 6Gb/s		
Network	• (1) 100	BBase-T ports (Intel® x710- 0Base-T port dedicate for k®RTL8211FD-CG)	, ,	SKU)
Video	· ASPEE	ED AST2600 Integrated Gr	aphics	
Management	• ASPEE	ED AST2600 iBMC w/ iKVN	VI	
Form Factor	• 12.15"	x 14.18"		
Standard Model	SATA	NVMe	10GbE	вмс
S7136GM2NRE-2T	14	(8) MCIO x4 + (2) M.2	2	Yes
S7136GMRE	14	(8) MCIO x4 + (2) M.2	-	Yes

Embedded

WS Board

Tempest EX S5565

S5565AG2NR

S5652AGMNRE

















7.1 Channel HD

Embedded

Tempest EX S5567















Embedded workstation motherboard in micro ATX form factor

Video	• (3) Display port		
Network	 (1) 2500Base-T port (Intel® i225-LM) (1) 1000Base-T port (Intel® i219-V) 		
Storage	• (6) SATA 6Gb/s		
Expansion	(1) PCle 3.0 x16 slot (2) PCle 3.0 x8 slots (w/ x4 link) (1) PCle 3.0 x4 NVMe M.2 slot (1) PCle 3.0 x2 NVMe M.2 slot		
Memory	• (4) DDR4 DIMM slots		
Processor	 (1) Intel[®] 12th Gen. Core[™] i3/i5/i7/i9 Processor 		

(2) M.2

Embedded motherboard in thin mini-ITX form factor

S5567G2NR	3	(1) M.2	1	1	-	
Standard Model	SATA	NVMe	2.5GbE	GbE	Audio	
Form Factor	• Thin Mi	• Thin Mini-ITX 6.69" x 6.69"				
Video	• (2) Disp	• (2) Display port				
Network	` '	• (1) 2500Base-T port (Intel® i225-LM) • (1) 1000Base-T port (Intel® i219-V)				
Storage	• (3) SAT	· (3) SATA 6Gb/s				
Expansion	` '	• (1) PCle 3.0 x16 slot • (1) PCle 3.0 x4 NVMe M.2 slot				
Memory	• (2) DDF	• (2) DDR4 SO-DIMM slots				
Processor	• (1) Intel	• (1) Intel® 12 th Gen. Core™ i3/i5/i7/i9 Processor				



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